

12V COMPLEMENTARY MEDIUM POWER TRANSISTOR IN SOT26

Features

- NPN + PNP Combination
- BV_{CEO} > 12 (-12)V
- BV_{EBO} > 7 (-7)V
- Continuous Collector Current I_C = 5 (-3.5)A
- V_{CE(sat)} < 32 (-70)mV @ 1A
- $R_{CE(sat)} = 25 (45) m\Omega$
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Description

Advanced process capability has been used to achieve this high performance device. Combining NPN and PNP transistors in the SOT26 package provides a compact solution for the intended applications.

Mechanical Data

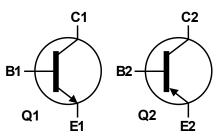
- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.015 grams (approximate)

Applications

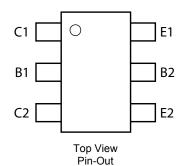
- MOSFET and IGBT Gate Driving
- Motor Drive







Device Symbol



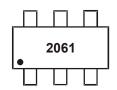
Ordering Information (Note 4)

Product Marking		Reel size (inches)	Tape width (mm)	Quantity per reel	
	ZXTC2061E6TA	2061	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/ for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
- 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com

Marking Information



2061 = Product Type Marking Code





Maximum Ratings - Q1 (NPN Transistor) (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	20	V
Collector-Emitter Voltage	V_{CEO}	12	V
Emitter-Base Voltage	V _{EBO}	7	V
Continuous Collector Current	Ic	5	Α
Peak Pulsed Collector Current	I _{CM}	12	Α
Base Current	I _B	1	Α

Maximum Ratings - Q2 (PNP Transistor) (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-12	V
Collector-Emitter Voltage	V _{CEO}	-12	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	lc	-3.5	Α
Peak Pulsed Collector Current	I _{CM}	-10	Α
Base Current	I _B	-1	Α

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

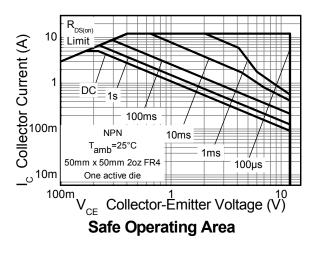
Characteristic		Symbol	Value	Unit	
	(Notes 5 & 9)		0.7 5.6		
	(Notes 6 & 9)		0.9 7.2	W mW/°C	
Power Dissipation Linear Derating Factor	(Notes 6 & 10)	P _D	1.1 8.8		
	(Notes 7 & 9)		1.1 8.8		
	(Notes 8 & 9)		1.7 13.6		
	(Notes 5 & 9)		179		
	(Notes 6 & 9)		139		
Thermal Resistance, Junction to Ambient	(Notes 6 & 10)	$R_{\theta JA}$	113	8C/M/	
	(Notes 7 & 9)		113	°C/W	
	(Notes 8 & 9)		73		
Thermal Resistance, Junction to Lead	(Note 11)	$R_{\theta JL}$	87.58		
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C		

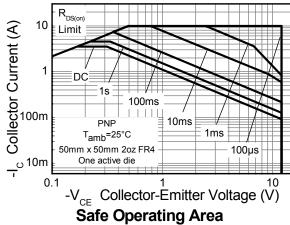
Notes:

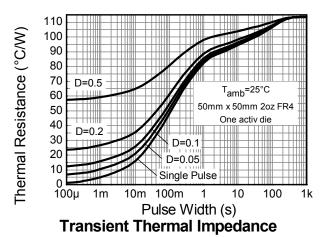
- 5. For a device surface mounted on 15mm x 15mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- Same as note (5), except the device is surface mounted on 25mm x 25mm 1oz copper.
 Same as note (5), except the device is surface mounted on 50mm x 50mm 2oz copper.
- 8. Same as note (7), except the device is measured at t < 5 seconds.
- 9. For device with one active die, both collectors attached to a common heatsink.
- 10. For device with two active dice running at equal power, split heatsink 50% to each collector.
- 11. Thermal resistance from junction to solder-point (at the end of the collector lead).

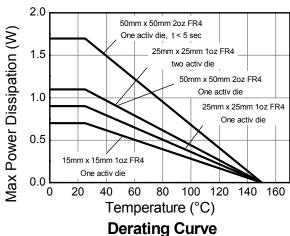


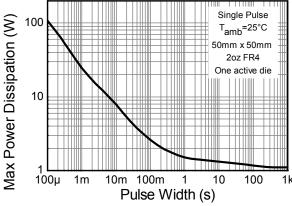
Thermal Characteristics and Derating Information













Electrical Characteristics - Q1 (NPN Transistor) (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV_{CBO}	20	40	_	V	$I_C = 100 \mu A, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 12)	BV_{CEO}	12	17	_	V	$I_C = 10 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	BV _{EBO}	7	8.4		V	$I_E = 100 \mu A, I_C = 0$
Collector Cutoff Current	I _{CBO}	-	<1	50 0.5	nΑ μΑ	V _{CB} = 20V V _{CB} = 20V, T _A = +100°C
Collector Cutoff Current	I _{EBO}		<1	50	nA	V _{EB} = 5.6V
ON CHARACTERISTICS (Note 12)						
DC Current Gain	h _{FE}	500 480 260	800 750 390	1500	l	I _C = 10mA, V _{CE} = 2V I _C = 1.0A, V _{CE} = 2V I _C = 5A, V _{CE} = 2V
Collector-Emitter Saturation Voltage	V _{CE(sat)}	_	32 50 65 145	40 60 80 180	mV	I_C = 1.0A, I_B = 100mA I_C = 1.0A, I_B = 10mA I_C = 2.0A, I_B = 40mA I_C = 5A, I_B = 100mA
Base-Emitter Saturation Voltage	V _{BE(sat)}	_	920	1000	mV	I _C = 5A, I _B = 100mA
Base-Emitter Turn-On Voltage	V _{BE(on)}	_	810	900	mV	$I_C = 5A, V_{CE} = 2V$
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	C_{obo}	1	26	35	pF	V _{CB} = 10V, f = 1.0MHz
Current Gain-Bandwidth Product	f_{T}	1	260	1	MHz	V _{CE} = 10V, I _C = 50mA, f = 100MHz
Delay Time	t _d		71	_	ns	
Rise Time Storage Time			70	1	ns	V _{CC} = 10V, I _C = 1A, I _{B1} = -I _{B2} = 10mA
			233	_	ns	$V_{CC} - 10V$, $I_{C} - 1A$, $I_{B1} = -I_{B2} = 10IIIA$
Fall Time	t _f	_	72	_	ns	

Notes: 12. Measured under pulsed conditions. Pulse width $\leq 300 \mu s$. Duty cycle $\leq 2\%$.





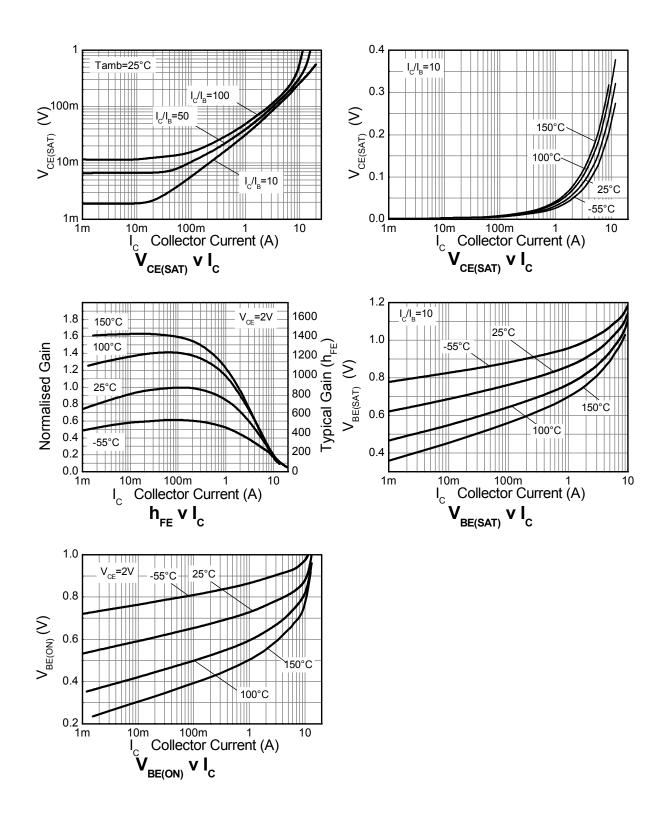
Electrical Characteristics – Q2 (PNP Transistor) (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV _{CBO}	-12	-35	_	V	$I_C = -100 \mu A, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 12)	BV_{CEO}	-12	-25	_	V	$I_C = -10 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	BV_{EBO}	-7	-8.4	_	V	$I_E = -100 \mu A, I_C = 0$
Collector Cutoff Current	I _{CBO}	_	< -1	-50 -0.5	nΑ μΑ	V _{CB} = -12V V _{CB} = -12V, T _A = +100°C
Collector Cutoff Current	I _{EBO}	_	< -1	-50	nA	V _{EB} = -5.6V
ON CHARACTERISTICS (Note 12)						
DC Current Gain	h _{FE}	500 290 75	800 450 100	1500 — —	_	I _C = -10mA, V _{CE} = -2V I _C = -1.0A, V _{CE} = -2V I _C = -3.5A, V _{CE} = -2V
Collector-Emitter Saturation Voltage	V _{CE(sat)}	_ _ _	-55 -170 -220 -150	-70 -265 -360 -200	mV	I _C = -1.0A, I _B = -100mA I _C = -1.0A, I _B = -10mA I _C = -2.0A, I _B = -40mA I _C = -3.5A, I _B = -350mA
Base-Emitter Saturation Voltage	V _{BE(sat)}	_	-955	-1050	mV	I _C = -3.5A, I _B = -350mA
Base-Emitter Turn-On Voltage	V _{BE(on)}	_	-830	-900	mV	I _C = -3.5A, V _{CE} = -2V
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	Cobo	_	17	25	pF	V _{CB} = -10V, f = 1.0MHz
Current Gain-Bandwidth Product	f_{T}	_	310	_	MHz	$V_{CE} = -10V$, $I_{C} = -50$ mA, $f = 100$ MHz
Delay Time	t _d	_	41	_	ns	
Rise Time	t _r	_	62	_	ns	$V_{CC} = -10V, I_{C} = -1A,$
Storage Time	ts	_	179	_	ns	$I_{B1} = -I_{B2} = -10 \text{mA}$
Fall Time	t _f	_	65	_	ns	

Notes: 12. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.



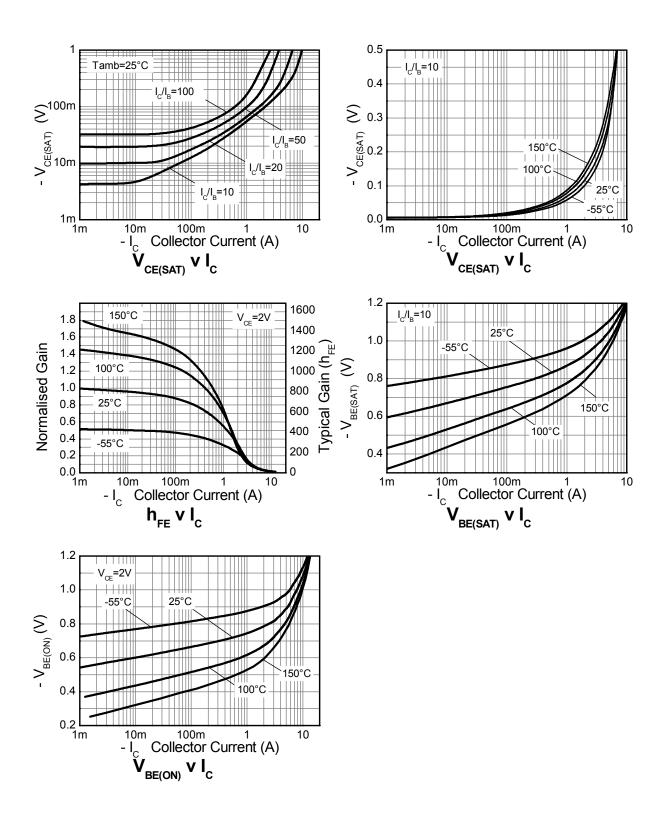
Typical Electrical Characteristics – Q1 (NPN Transistor) (@TA = +25°C, unless otherwise specified.)







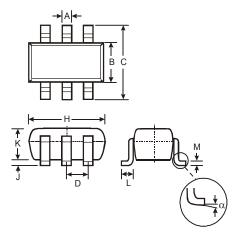
Typical Electrical Characteristics - Q2 (PNP Transistor) (@TA = +25°C, unless otherwise specified.)





Package Outline Dimensions

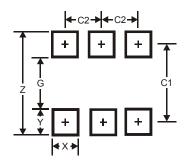
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT26						
Dim	Min	Max	Тур			
Α	0.35	0.50	0.38			
В	1.50	1.70	1.60			
ပ	2.70	3.00	2.80			
D	_		0.95			
Н	2.90	3.10	3.00			
ے	0.013	0.10	0.05			
K	1.00	1.30	1.10			
Г	0.35	0.55	0.40			
M	0.10	0.20	0.15			
α	0°	8°	_			
All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	3.20
G	1.60
X	0.55
Y	0.80
C1	2.40
C2	0.95





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